

July 2009

FOD410, FOD4108, FOD4116, FOD4118 6-Pin DIP Zero-Cross Triac Drivers

Features

- 300mA on-state current
- Zero-voltage crossing
- High blocking voltage
 - -800V (FOD4108, FOD4118)
 - -600V (FOD410, FOD4116)
- High trigger sensitivity
 - 1.3mA (FOD4116, FOD4118)
 - -2mA (FOD410, FOD4108)
- High static dv/dt (10,000V/µs)
- UL, VDE, CSA approved
- Lead free assembly

Applications

- Solid-state relays
- Industrial controls
- Lighting controls
- Static power switches
- AC motor starters

Description

The FOD410, FOD4108, FOD4116 and FOD4118 devices consist of an infrared emitting diode coupled to a hybrid triac formed with two inverse parallel SCRs which form the triac function capable of driving discrete triacs. The FOD4116 and FOD4118 utilize a high efficiency infrared emitting diode which offers an improved trigger sensitivity. These devices are housed in a standard 6-pin dual in-line (DIP) package.

Package Schematic ANODE 1 ANODE 2 CATHODE 2 *DO NOT CONNECT (TRIAC SUBSTRATE)

©2004 Fairchild Semiconductor Corporation FOD410, FOD4108, FOD4116, FOD4118 Rev. 1.5.0

Absolute Maximum Ratings (T_A = 25°C unless otherwise noted)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameters Device		Value	Units
TOTAL DE	EVICE			1
T _{STG}	Storage Temperature	All	-55 to +150	°C
T _{OPR}	Operating Temperature	All	-55 to +100	°C
T _{SOL}	Lead Solder Temperature (Wave)	All	260 for 10 sec	°C
TJ	Junction Temperature Range	All	125	°C
V _{ISO}	Isolation Test Voltage ⁽¹⁾ (rms AC voltage, 60Hz, 1 min. duration)	All	5000	Vac(rms)
P _{DTOTAL}	Total Device Power Dissipation @ 25°C	All	500	mW
	Derate above 25°C			mW/°C
EMITTER				
IF	Continuous Forward Current	All	30	mA
V _R	Reverse Voltage	All	6	V
P _{DE}	Total Power Dissipation 25°C Ambient	All	50	mW
	Derate above 25°C		0.71	mW/°C
DETECTO	PR			
V_{DRM}	Off-State Output Terminal Voltage	FOD410, FOD4116	600	V
		FOD4108, FOD4118	800	1
I _{TSM}	Peak Non-Repetitive Surge Current (single cycle 60Hz sine wave)	All	3	А
I _{TM}	Peak On-State Current	All	300	mA
P _{DDET}	Total Power Dissipation @ 25°C Ambient	All	450	mW
	Derate above 25°C		5.9	mW/°C

Note

1. Isolation voltage, V_{ISO}, is an internal device dielectric breakdown rating. For this test, Pins 1, 2 and 3 are common, and Pins 4, 5 and 6 are common. 5,000 VRMS for 1 minute duration is equivalent to 6,000 VRMS for 1 second duration.

Electrical Characteristics (T_A = 25°C Unless otherwise specified)

Individual Component Characteristics

Symbol	Parameters	Test Cond	litions	Device	Min.	Тур.*	Max	Units
EMITTER				1				
V _F	Input Forward Voltage	I _F = 20mA		All		1.25	1.5	V
I _R	Reverse Leakage Current	V _R = 6V		All		0.0001	10	μA
DETECTO	DR			1				
I _{D(RMS)}	Peak Blocking Current, Either Direction	$I_F = 0,$ $T_A = 100^{\circ}C^{(2)}$	V _D = 800V	FOD4108, FOD4118		3	100	μA
			V _D = 600V	FOD410, FOD4116				
I _{R(RMS)}	Reverse Current	T _A = 100°C	V _D = 800V	FOD4108, FOD4118		3	100	μA
			V _D = 600V	FOD410, FOD4116				
dv/dt	Critical Rate of Rise of Off-State Voltage	$I_F = 0^{(4)}$ (Fig. 11)			10,000			V/µs

Transfer Characteristics

Symbol	DC Characteristics	Test (Conditions	Device	Min.	Тур.*	Max.	Units
I _{FT}	LED Trigger Current	Main Terminal Voltage = 5V ⁽³⁾		FOD410, FOD4108		0.65	2.0	mA
				FOD4116, FOD4118		0.65	1.3	
V _{TM}	Peak On-State Voltage, Either Direction	I _{TM} = 300 mA peal	k, I _F = rated I _{FT}	All		2.2	3	V
I _H	Holding Current, Either Direction	V _T = 3V		All		200	500	μA
ΙL	Latching Current	V _T = 2.2V		All		5		mA
t _{ON}	Turn-On Time	PF = 1.0,	V _{RM} = V _{DM} = 565 VAC	FOD4108		60		μs
		I _T = 300mA	V _{RM} = V _{DM} = 424 VAC	FOD410, FOD4116, FOD4118				
t _{OFF}	Turn-Off Time		V _{RM} = V _{DM} = 565 VAC	FOD4108		52		μs
			$V_{RM} = V_{DM} = 424 \text{ VAC}$	FOD410, FOD4116, FOD4118				
dv/dt _{crq}	Critical Rate of Rise of	$V_D = 0.67 V_{DRM}$	T _j = 25°C	All	10,000			V/µs
	Voltage at Current Commutation	di/dt _{crq} ≤ 15 A/ms	T _j = 80°C		5,000			5)
di/dt _{cr}	Critical Rate of Rise of On-State Current			All			8	A/µs
dV(IO)/dt	Critical Rate of Rise of Coupled Input/Output Voltage	$I_T = 0A$, $V_{RM} = V_{DM} = 424$	VAC	All		10,000		V/µs

^{*}Typical values at $T_A = 25$ °C

Electrical Characteristics (T_A = 25°C Unless otherwise specified) (Continued)

Zero Crossing Characteristics

Symbol	DC Characteristics	Test Conditions	Min.	Тур.*	Max.	Units
V _{INH}	Inhibit Voltage (MT1-MT2 voltage above which device will not trigger)	I _F = Rated I _{FT}		8	25	V
I _{DRM2}	Leakage in Inhibited State	I _F = Rated I _{FT} ,		20	200	μA
		Rated V _{DRM} , off state				

Isolation Characteristics

Symbol	Characteristics	Test Conditions	Min.	Typ.*	Max.	Units
V _{ISO}	Input-Output Isolation Voltage	f = 60Hz, t = 1 min. ⁽⁵⁾	5000			Vac(rms)

^{*}Typical values at T_A = 25°C

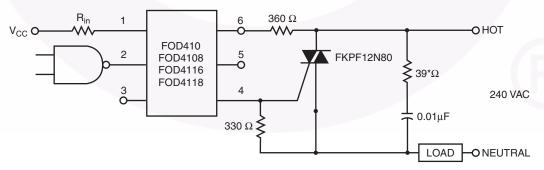
Notes:

- 2. Test voltage must be applied within dv/dt rating.
- 3. All devices are guaranteed to trigger at an I_F value less than or equal to max I_{FT}. Therefore, recommended operating I_F lies between max I_{FT} (2mA for FOD410 and FOD4108 and 1.3mA for FOD4116 and FOD4118 and the absolute max I_F (60mA).
- 4. This is static dv/dt. See Figure 11 for test circuit. Commutating dv/dt is a function of the load-driving thyristor(s) only.
- 5. Isolation voltage, $V_{\rm ISO}$, is an internal device dielectric breakdown rating. For this test, Pins 1, 2 and 3 are common, and Pins 4, 5 and 6 are common.

Typical Application

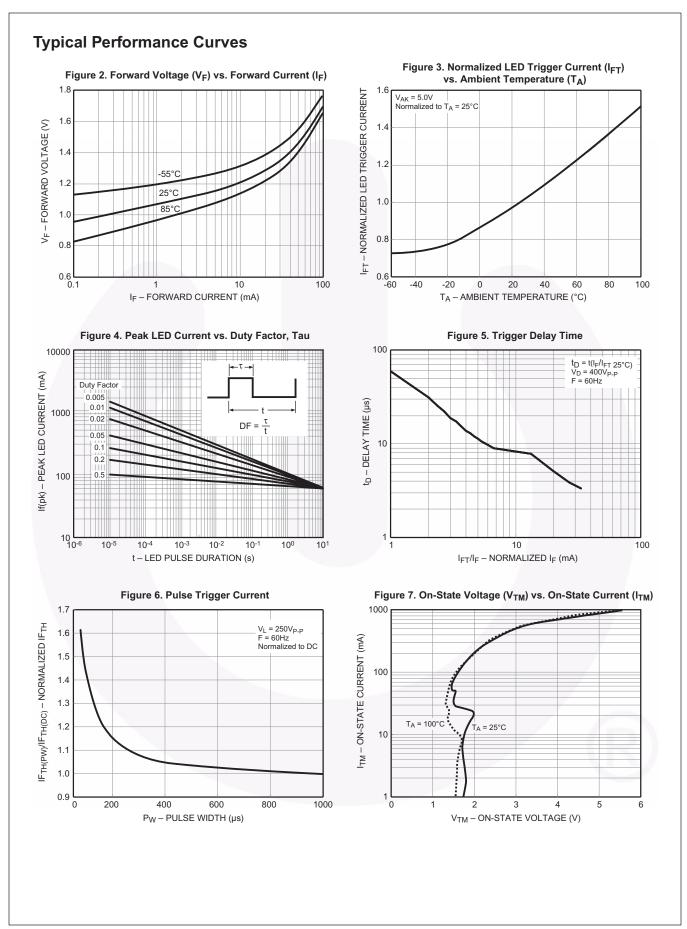
Typical circuit for use when hot line switching is required. In this circuit the "hot" side of the line is switched and the load connected to the cold or neutral side. The load may be connected to either the neutral or hot line.

 R_{in} is calculated so that I_F is equal to the rated I_{FT} of the part, 2mA for FOD410 and FOD4108, 1.3mA for FOD4116 and FOD4118. The 39Ω resistor and $0.01\mu\text{F}$ capacitor are for snubbing of the triac and may or may not be necessary depending upon the particular triac and load use.

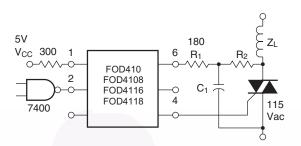


^{*} For highly inductive loads (power factor < 0.5), change this value to 360 ohms.

Figure 1. Hot-Line Switching Application Circuit



Typical Performance Curves (Continued) Figure 9. Normalized Off-State Current (IDRM) Figure 8. Normalized Holding Current (I_H) vs. Ambient Temperature (T_A) vs. Ambient Temperature (T_A) 2.2 Normalized to T_A = 25°C I_{DRM} – NORMALIZED OFF-STATE CURRENT V_D = 800V, I_{BD} (μA) IH - NORMALIZED HOLDING CURRENT Normalized to $T_{\Delta} = 25^{\circ}C$ 2.0 1.8 1.6 1.4 1.2 1.0 0.8 L -60 0.1 -40 80 -60 -40 -20 0 20 40 60 80 100 20 40 60 100 T_A – AMBIENT TEMPERATURE (°C) TA - AMBIENT TEMPERATURE (°C) Figure 10. Normalized Inhibit Voltage (VINH) Figure 11. Normalized Leakage in Inhibit State (IDRM2) vs. Ambient Temperature (T_A) vs. Ambient Temperature (TA) 1.2 2.5 I_F = Rated I_{FT} V_{DRM} = 600V Normalized to T_A = 25°C IDRM2 (NORM) = IDRM2 (TA) / IDRM2 (25°C) I_F = Rated I_{FT} V_{INH} (NORM) = V_{INH} (T_A) / V_{INH} (25°C) Normalized to T_A = 25°C 2.0 1.5 1.0 1.0 0.9 0.5 0.0 0.8 -40 0 20 40 60 80 -40 -20 40 60 80 -60 -20 100 -60 0 20 100 T_A – AMBIENT TEMPERATURE (°C) T_A – AMBIENT TEMPERATURE (°C) Figure 12. Current Reduction 350 $I_{TP} = f(T_A)$ ITP - PEAK ON-STATE CURRENT (mA) 300 250 200 150 100 50 L -60 -40 0 20 40 100 T_A – AMBIENT TEMPERATURE (°C)



NOTE: Circuit supplies 25mA drive to gate of triac at V_{in} = 25V and T_A < 70°C

TRIAC					
I _{GT}	R ₂	С			
15 mA	2400	0.1			
30 mA	1200	0.2			
50 mA	800	0.3			

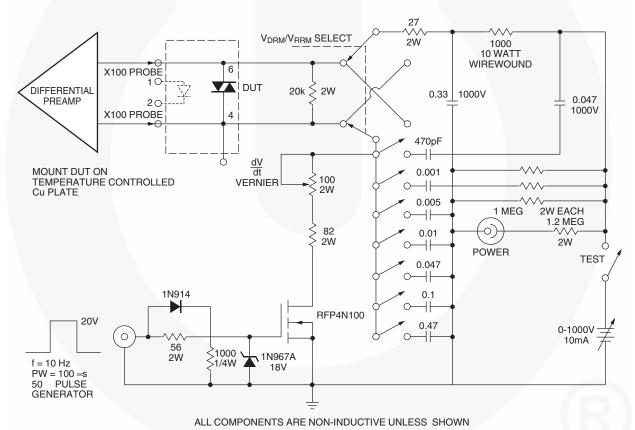


Figure 11. Circuit for Static $\frac{dV}{dt}$ Measurement of Power Thyristors

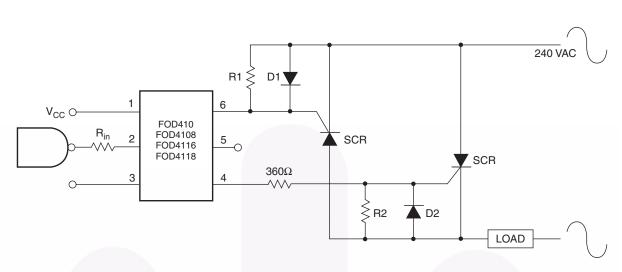


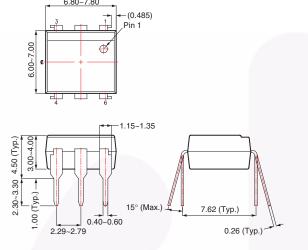
Figure 12. Inverse-Parallel SCR Driver Circuit

Suggested method of firing two, back-to-back SCR's with a Fairchild triac driver. Diodes can be 1N4001; resistors, R1 and R2, are optional 330Ω .

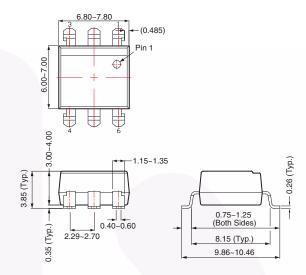
Note: This optoisolator should not be used to drive a load directly. It is intended to be a discrete triac driver device only.

Package Dimensions

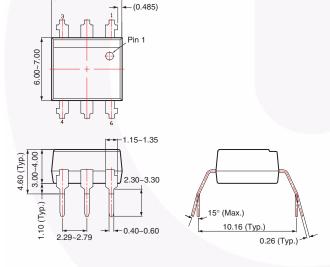
Through Hole



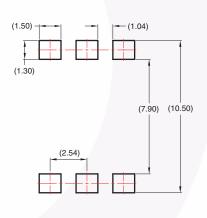
Surface Mount



0.4" Lead Spacing



Recommended Pad Layout for Surface Mount Leadforms



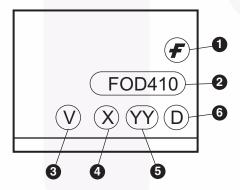
Note:

All dimensions are in millimeters.

Ordering Information

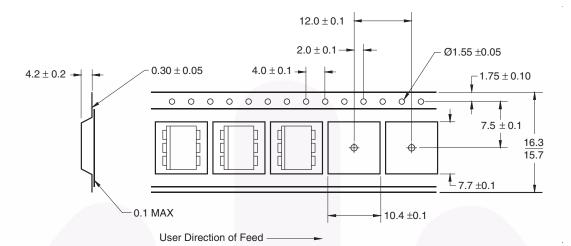
Option	Order Entry Identifier (example)	Description	
None	FOD410	Standard Through Hole Device	
S	FOD410S	Surface Mount Lead Bend	
SD	FOD410SD	Surface Mount; Tape and reel	
Т	FOD410T	0.4" Lead Spacing	
V	FOD410V	IEC60747-5-2 certification	
TV	FOD410TV	IEC60747-5-2 certification, 0.4" Lead Spacing	
SV	FOD410SV	IEC60747-5-2 certification, Surface Mount	
SDV	FOD410SDV	IEC60747-5-2 certification, Surface Mount, Tape & Reel	

Marking Information



Definiti	Definitions					
1	Fairchild logo					
2	Device number					
3	VDE mark indicates IEC60747-5-2 certified (Note: Only appears on parts ordered with VDE option – See order entry table)					
4	One digit year code, e.g., '7'					
5	Two digit work week ranging from '01' to '53'					
6	Assembly package code					

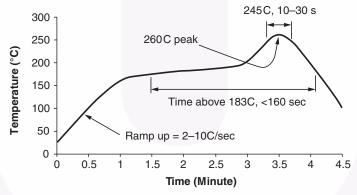
Carrier Tape Specifications



Note:

All dimensions are in inches (millimeters).

Reflow Profile



- Peak reflow temperature: 260 C (package surface temperature)
 Time of temperature higher than 183 C for 160 seconds or less
 One time soldering reflow is recommended





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Definition of Terms

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